

General Description

The WSF3040 is the highest performance trench N-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF3040 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summery

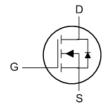
BVDSS	RDSON	ID
30V	10mΩ	43A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

TO-252 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	30	V	
V_{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	43	Α	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	30	Α	
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	11	Α	
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	9	Α	
I _{DM}	Pulsed Drain Current ²	112	Α	
EAS	Single Pulse Avalanche Energy ³	53	mJ	
I _{AS}	Avalanche Current	22	Α	
P _D @T _C =25℃	Total Power Dissipation ⁴	37.5	W	
P _D @T _A =25℃	Total Power Dissipation ⁴	2	W	
T _{STG}	Storage Temperature Range	-55 to 175	$^{\circ}$	
T_J	Operating Junction Temperature Range -55 to 175		$^{\circ}$ C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		4	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25 $^{\circ}$ C , I _D =1mA		0.0193		V/°C
D	Static Drain-Source On-Resistance ² V _{GS} =10V , I _D =30A	V _{GS} =10V , I _D =30A		10	12	m 0
R _{DS(ON)}	Static Dialii-Source Off-Resistance	V _{GS} =4.5V , I _D =15A		15	18	mΩ
$V_{GS(th)}$	Gate Threshold Voltage		1.2	1.5	2.5	٧
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			-3.97		mV/℃
	Drain Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C V _{DS} =24V , V _{GS} =0V , T _J =55°C			1	
I _{DSS}	Drain-Source Leakage Current				5	· uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		34		S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.8	3.6	Ω
Q_g	Total Gate Charge (4.5V)			9.8	13.7	
Q _{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		4.2	5.88	nC
Q_{gd}	Gate-Drain Charge			3.6	5.0	
T _{d(on)}	Turn-On Delay Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω		5	8.0	
T _r	Rise Time			8	14	20
$T_{d(off)}$	Turn-Off Delay Time			31	62	ns
T _f	Fall Time			4	8	
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		940	1316	
C _{oss}	Output Capacitance			131	183	pF
C _{rss}	Reverse Transfer Capacitance			109	153	

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.1mH , I _{AS} =15A	24.6			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current ^{1,6}	V V 0V 5 0:			15	Α
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			112	Α
V_{SD}	Diode Forward Voltage ²	V_{GS} =0 V , I_{S} =1 A , T_{J} =25 $^{\circ}$ C			1	V
t _{rr}	Reverse Recovery Time			8.5		nS
Qrr	Reverse Recovery Charge	lF=30A , dl/dt=100A/μs , T _J =25℃		2.2		nC

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =15A
- 4.The power dissipation is limited by 175 $^{\circ}\mathrm{C}\,$ junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

Typical Characteristics

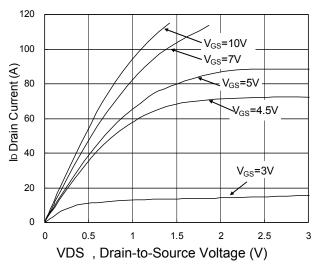


Fig.1 Typical Output Characteristics

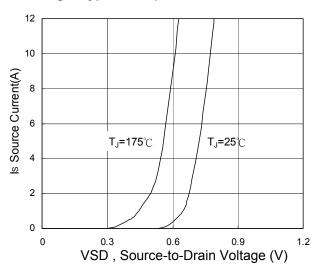
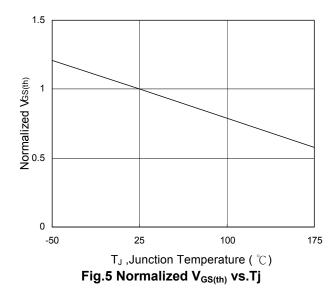


Fig.3 Forward Characteristics of Reverse



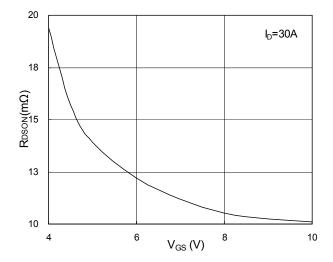


Fig.2 On-Resistance vs. G-S Voltage

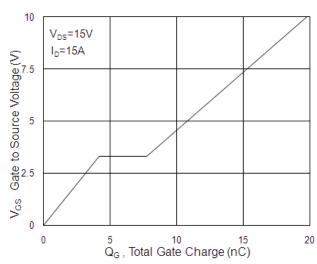


Fig.4 Gate-Charge Characteristics

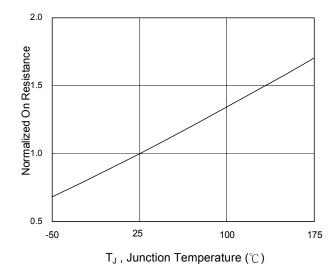
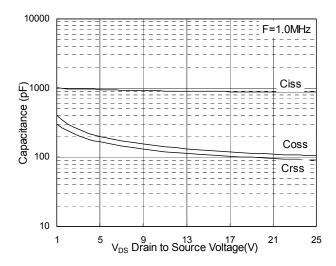


Fig.6 Normalized R_{DSON} vs. T_J





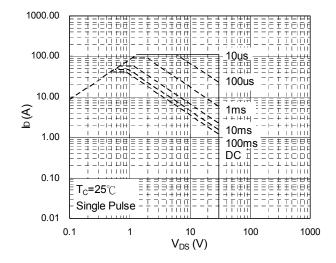


Fig.7 Capacitance

Fig.8 Safe Operating Area

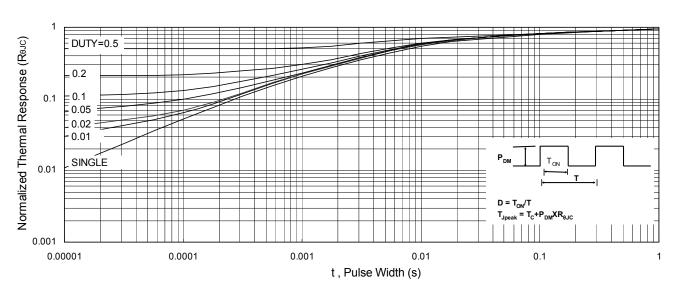


Fig.9 Normalized Maximum Transient Thermal Impedance

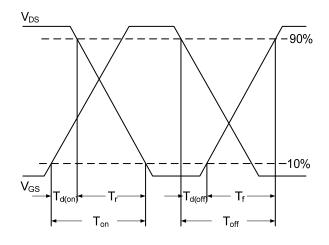


Fig.10 Switching Time Waveform

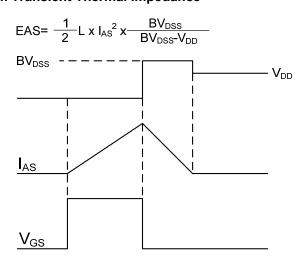


Fig.11 Unclamped Inductive Switching Waveform



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